

HPL EVM PROGRAM

Dear Customer:

Thank you for your interest in the 1.5 Gbps differential repeater evaluation module (EVM) from Texas Instruments.

This EVM kit includes either the SN65LVDS100 or SN65LVDS101 installed on the PWB. The latest SN65LVDS100/101 data sheet and EVM users guide are also included.

We remind you that the most up-to-data data sheets are always available from:

http://www.ti.com

If you have any questions regarding your EVM kit, contact your local distributor or your TI product information center. Phone, fax and e-mail contact details are available at:

http://www-k.ext.ti.com/sc/technical_support



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. Modules should be stored in their protective ESD bag.

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